

MDP13N50B / MDF13N50B

N-Channel MOSFET 500V, 13.0 A, 0.5Ω

General Description

The MDP/F13N50B uses advanced Magnachip's MOSFET Technology, which provides low on-state resistance, high switching performance and excellent quality.

MDP/F13N50B is suitable device for SMPS, HID and general purpose applications.

Features

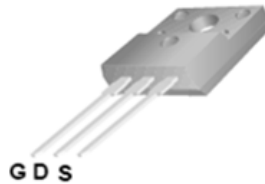
- $V_{DS} = 500V$
- $I_D = 13.0A$ @ $V_{GS} = 10V$
- $R_{DS(ON)} \leq 0.5\Omega$ @ $V_{GS} = 10V$

Applications

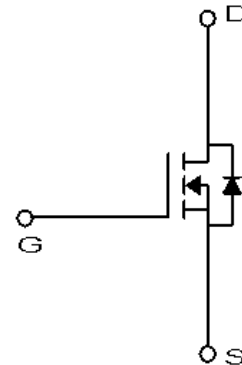
- Power Supply
- PFC
- Ballast



TO-220
MDP Series



TO-220F
MDF Series



Absolute Maximum Ratings ($T_a = 25^\circ C$)

Characteristics		Symbol	MDP13N50B	MDF13N50B	Unit
Drain-Source Voltage		V_{DSS}	500		V
Gate-Source Voltage		V_{GSS}	± 30		V
Continuous Drain Current	$T_C = 25^\circ C$	I_D	13	13*	A
	$T_C = 100^\circ C$		8.2	8.2*	A
Pulsed Drain Current ⁽¹⁾		I_{DM}	52	52*	A
Power Dissipation	$T_C = 25^\circ C$	P_D	187	41	W
	Derate above $25^\circ C$		1.49	0.33	W/ $^\circ C$
Repetitive Avalanche Energy ⁽¹⁾		E_{AR}	18.7		mJ
Peak Diode Recovery dv/dt ⁽³⁾		dv/dt	4.5		V/ns
Single Pulse Avalanche Energy ⁽⁴⁾		E_{AS}	580		mJ
Junction and Storage Temperature Range		T_J, T_{stg}	-55~150		$^\circ C$

* I_D limited by maximum junction temperature

Thermal Characteristics

Characteristics	Symbol	MDP13N50B	MDF13N50B	Unit
Thermal Resistance, Junction-to-Ambient ⁽¹⁾	$R_{\theta JA}$	62.5	62.5	$^\circ C/W$
Thermal Resistance, Junction-to-Case ⁽¹⁾	$R_{\theta JC}$	0.67	3.05	

Ordering Information

Part Number	Temp. Range	Package	Packing	RoHS Status
MDP13N50BTH	-55~150°C	TO-220	Tube	Halogen Free
MDF13N50BTH	-55~150°C	TO-220F	Tube	Halogen Free

Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	I _D = 250μA, V _{GS} = 0V	500	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	2.0	-	4.0	
Drain Cut-Off Current	I _{DSS}	V _{DS} = 500V, V _{GS} = 0V	-	-	1	μA
Gate Leakage Current	I _{GSS}	V _{GS} = ±30V, V _{DS} = 0V	-	-	100	nA
Drain-Source ON Resistance	R _{DS(ON)}	V _{GS} = 10V, I _D = 6.5A	-	0.39	0.5	Ω
Forward Transconductance	g _{fs}	V _{DS} = 40V, I _D = 6.5A	-	13	-	S
Dynamic Characteristics						
Total Gate Charge	Q _g	V _{DS} = 400V, I _D = 13.0A, V _{GS} = 10V ⁽³⁾	-	27	-	nC
Gate-Source Charge	Q _{gs}		-	6.3	-	
Gate-Drain Charge	Q _{gd}		-	8.6	-	
Input Capacitance	C _{iss}	V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz	-	1459	-	pF
Reverse Transfer Capacitance	C _{rss}		-	7.4	-	
Output Capacitance	C _{oss}		-	174	-	
Turn-On Delay Time	t _{d(on)}	V _{GS} = 10V, V _{DS} = 250V, I _D = 13.0A, R _G = 25Ω ⁽³⁾	-	21	-	ns
Rise Time	t _r		-	47	-	
Turn-Off Delay Time	t _{d(off)}		-	131	-	
Fall Time	t _f		-	54	-	
Drain-Source Body Diode Characteristics						
Maximum Continuous Drain to Source Diode Forward Current	I _S		-	13	-	A
Source-Drain Diode Forward Voltage	V _{SD}	I _S = 13.0A, V _{GS} = 0V	-	-	1.4	V
Body Diode Reverse Recovery Time	t _{rr}	I _F = 13.0A, dI/dt = 100A/μs ⁽³⁾	-	325	-	ns
Body Diode Reverse Recovery Charge	Q _{rr}		-	2.9	-	μC

Note :

1. Pulse width is based on $R_{\theta JC}$ & $R_{\theta JA}$ and the maximum allowed junction temperature of 150°C.
2. Pulse test: pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$, pulse width limited by junction temperature $T_{J(MAX)} = 150^\circ C$.
3. $I_{SD} \leq 13.0A$, $di/dt \leq 200A/\mu s$, $V_{DD} \leq BV_{DSS}$, $R_G = 25\Omega$, Starting $T_J = 25^\circ C$
4. $L = 6.2mH$, $I_{AS} = 13.0A$, $V_{DD} = 50V$, $R_G = 25\Omega$, Starting $T_J = 25^\circ C$

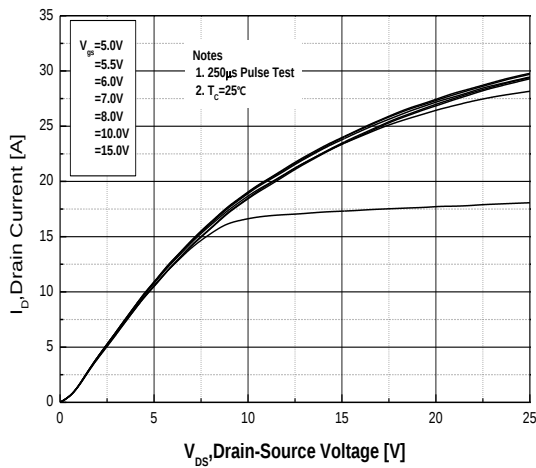


Fig.1 On-Region Characteristics

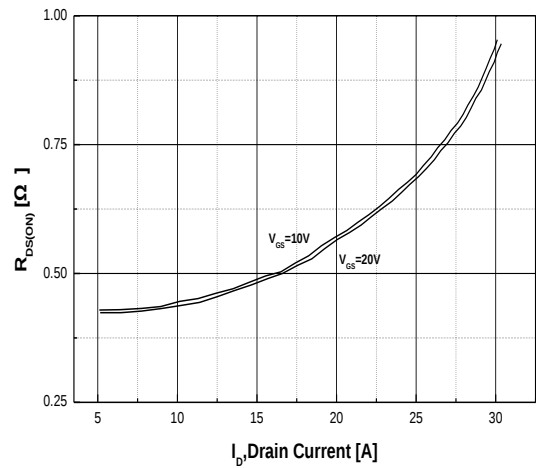


Fig.2 On-Resistance Variation with Drain Current and Gate Voltage

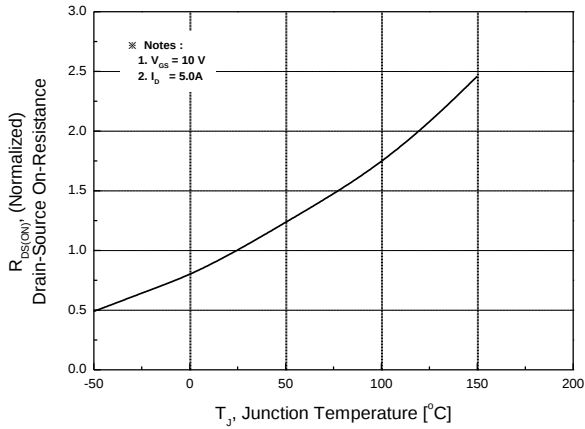


Fig.3 On-Resistance Variation with Temperature

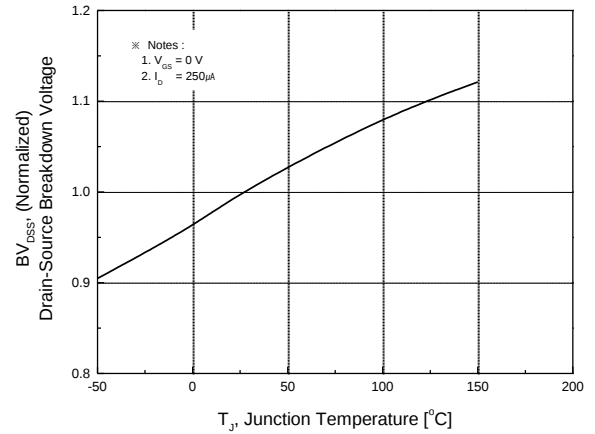


Fig.4 Breakdown Voltage Variation vs. Temperature

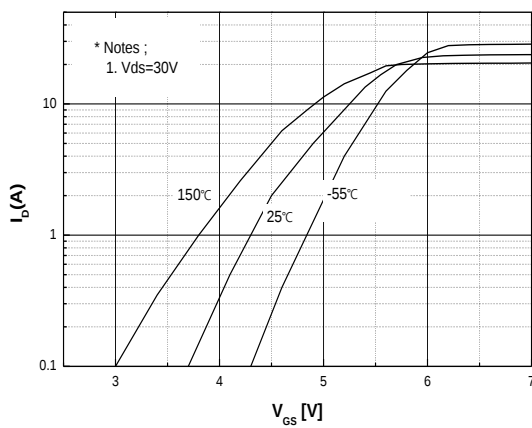


Fig.5 Transfer Characteristics

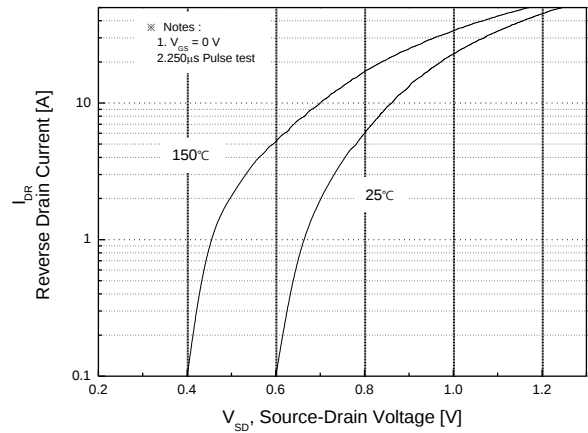


Fig.6 Body Diode Forward Voltage Variation with Source Current and Temperature

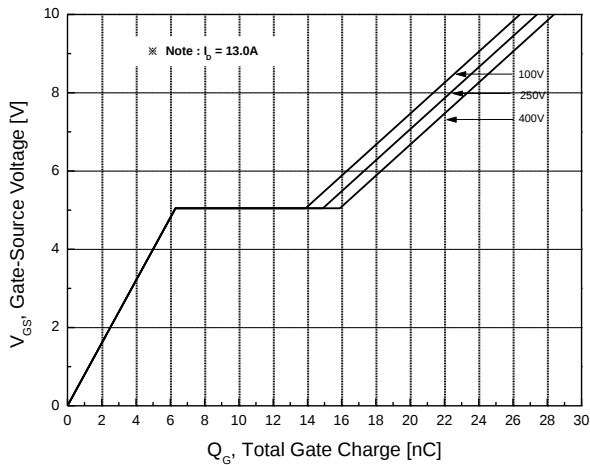


Fig.7 Gate Charge Characteristics

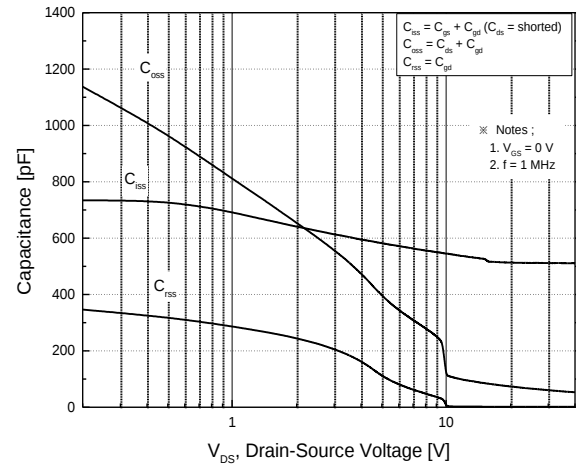
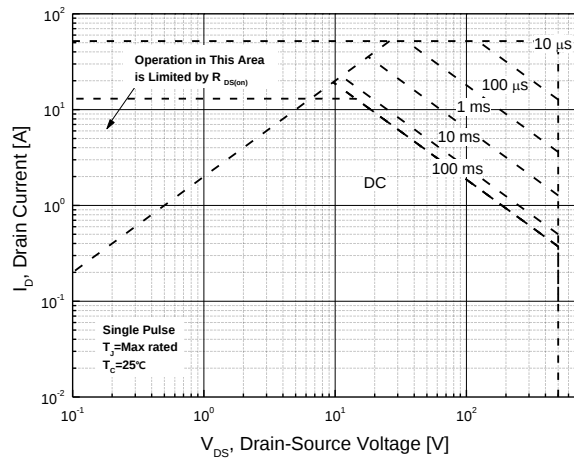
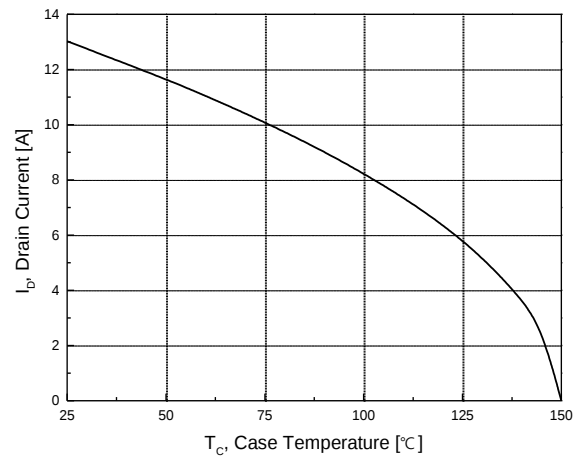
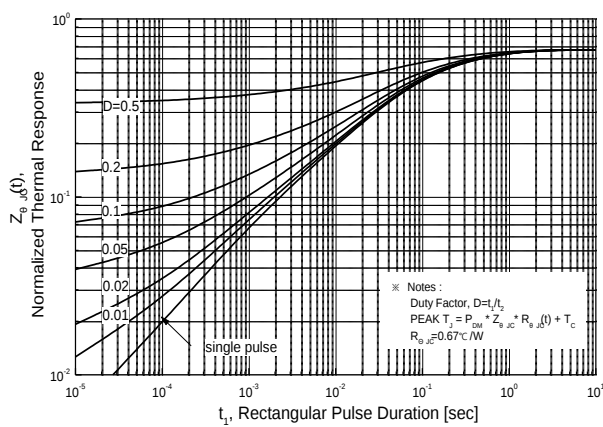
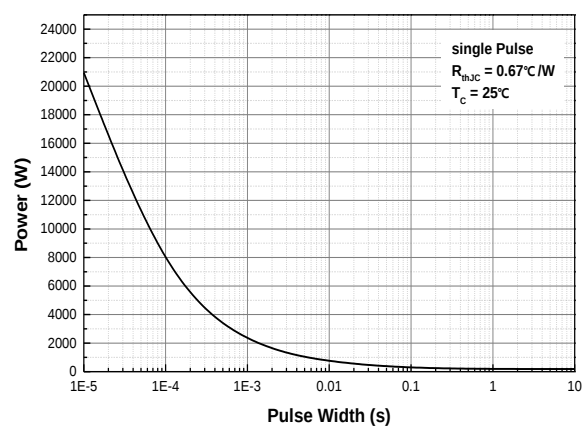
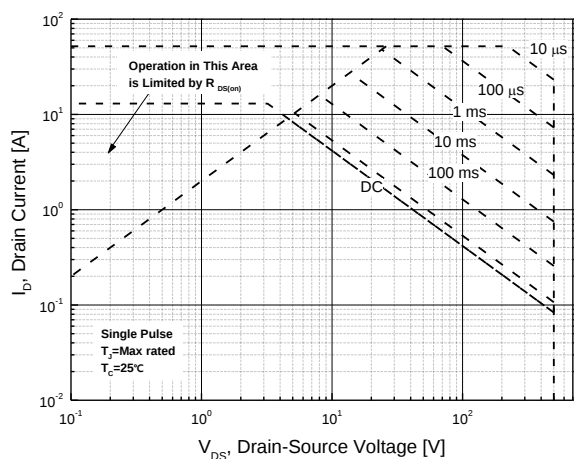
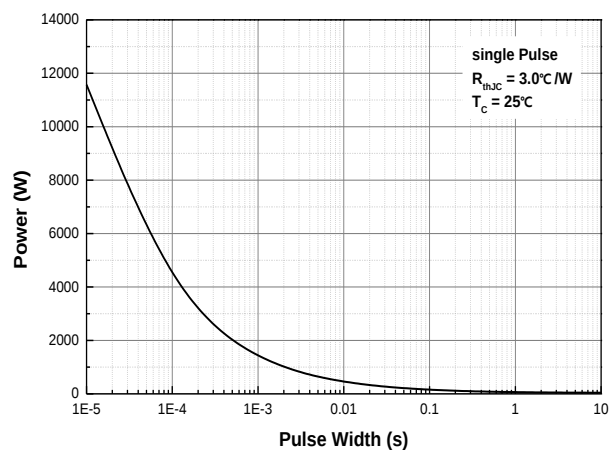


Fig.8 Capacitance Characteristics

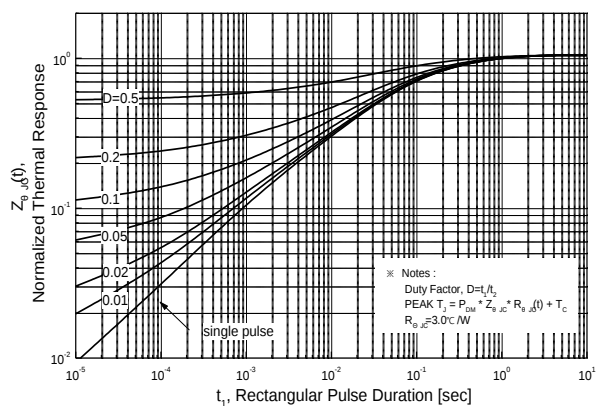
Fig.9 Maximum Safe Operating Area
MDP13N50B (TO-220)Fig.10 Maximum Drain Current vs. Case
TemperatureFig.11 Transient Thermal Response Curve
MDP13N50B (TO-220)Fig.12 Single Pulse Maximum Power
Dissipation – MDP13N50B (TO-220)



**Fig.13 Maximum Safe Operating Area
MDF13N50B (TO-220F)**



**Fig.14 Single Pulse Maximum Power
Dissipation – MDF13N50B (TO-220F)**

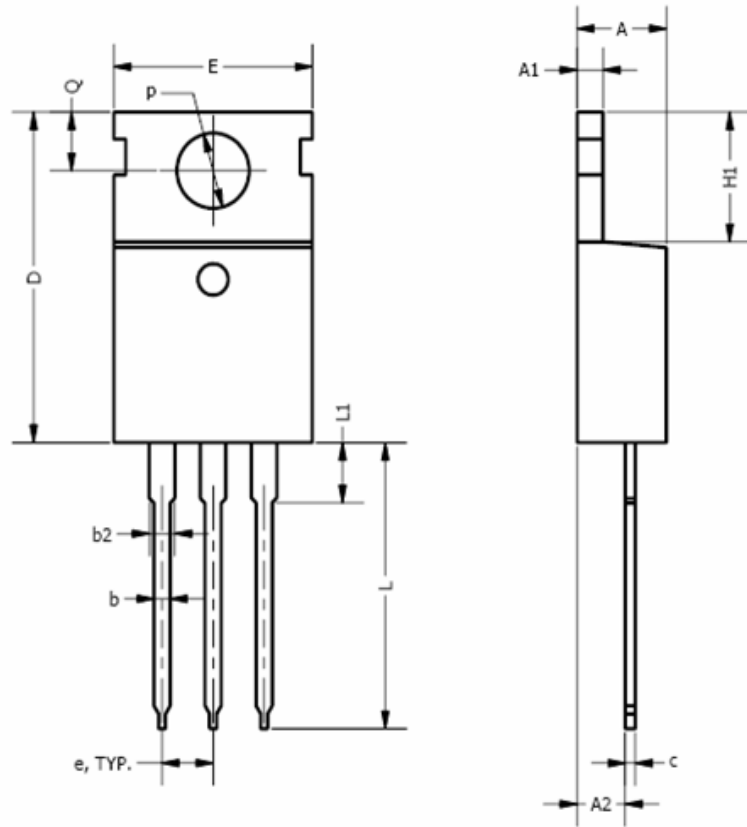


**Fig.15 Transient Thermal Response Curve
MDF13N50B (TO-220F)**

Physical Dimensions

3 Leads, TO-220

Dimensions are in millimeters unless otherwise specified



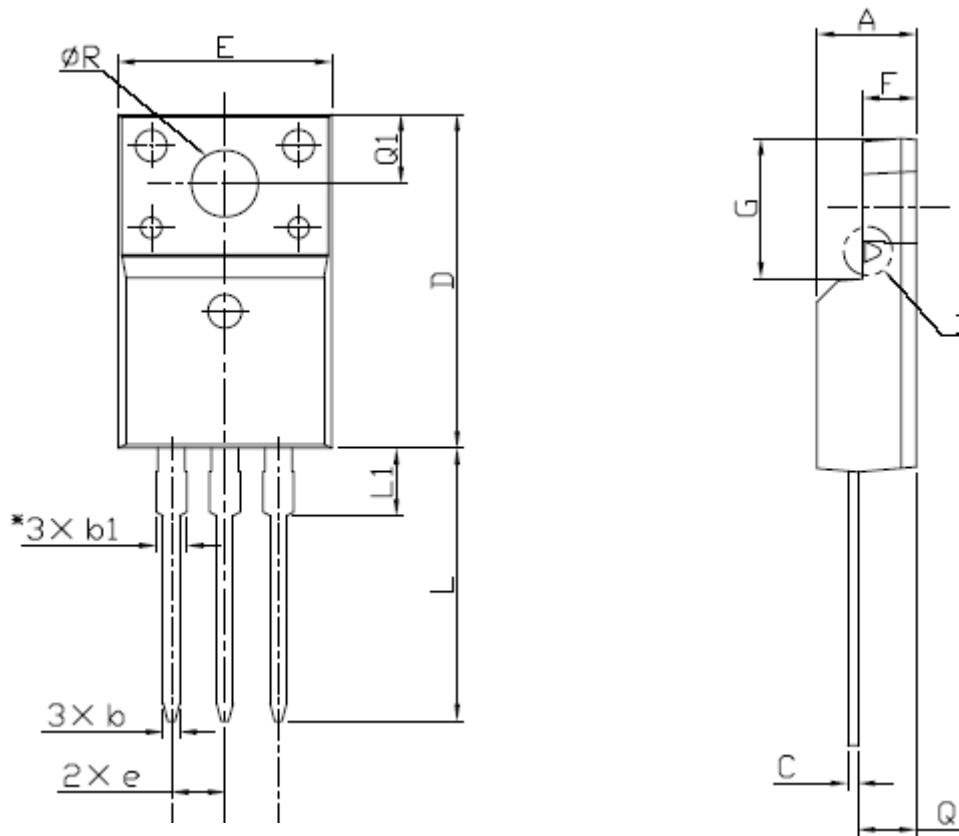
Symbol	Min	Nom	Max
A	3.56		4.83
A1	0.50		1.40
A2	2.03		2.92
b	0.38	0.69	1.02
b2	1.14	1.45	1.78
c	0.36		0.61
D	14.22		16.51
e	2.54 TYP		
E	9.65		10.67
H1	5.84		6.86
L	12.70		14.73
L1			6.35
ϕP	3.53		4.09
Q	2.54		3.43

Note : Package body size, length and width do not include mold flash, protrusions and gate burrs.

Physical Dimension

3 Leads, TO-220F

Dimensions are in millimeters unless otherwise specified



Symbol	Min	Nom	Max
A	4.50		4.93
b	0.63		0.91
b1	1.15		1.47
C	0.33		0.63
D	15.47		16.13
E	9.60		10.71
e		2.54	
F	2.34		2.84
G	6.48		6.90
L	12.24		13.72
L1	2.79		3.67
Q	2.52		2.96
Q1	3.10		3.50
ØR	3.00		3.55

Note : Package body size, length and width do not include mold flash, protrusions and gate burrs.

DISCLAIMER:

The Products are not designed for use in hostile environments, including, without limitation, aircraft, nuclear power generation, medical appliances, and devices or systems in which malfunction of any Product can reasonably be expected to result in a personal injury. Seller's customers using or selling Seller's products for use in such applications do so at their own risk and agree to fully defend and indemnify Seller.

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